M2S060-FGG676 Information

For Reference Only

Part Number	M2S060-FGG676
Manufacturer	Microsemi Corporation
Category	Integrated Circuits (ICs)
	Embedded - System On Chip (SoC)
Description	IC FPGA SOC 60K LUTS
Package	676-BGA

For the pricing/inventory/lead time, please contact us
Website: https://www.heisener.com
E-mail: salesdept@heisener.com

Request a Quote

Certified Quality

Heisener's commitment to quality has shaped our processes for sourcing, testing, shipping, and every step in between. This foundation underlies each component we sell.

M2S060-FGG676 Specifications

Manufacturer Part Number	M2S060-FGG676
Manufacturer	Microsemi Corporation
Category	Integrated Circuits (ICs)
	Embedded - System On Chip (SoC)
Package	676-BGA
Series	SmartFusion?2
Architecture	MCU, FPGA
Core Processor	ARM? Cortex?-M3
Flash Size	256KB
RAM Size	64KB
Peripherals	DDR, PCIe, SERDES
Connectivity	CAN, Ethernet, I2C, SPI, UART/USART, USB
Speed	166MHz
Primary Attributes	FPGA - 60K Logic Modules
Operating Temperature	0°C ~ 85°C (TJ)
Package / Case	676-BGA
Supplier Device Package	676-FBGA (27x27)
	Report errors?

M2S060-FGG676 Guarantees

Quality Guarantees
We provide 90 days warranty. *
If the items you received were not in perfect quality, we would be responsible for your refund or replacement, but the items must be returned in their original condition.

Service Guarantees
We guarantee 100% customer satisfaction.
Our experienced sales team and tech support team back our services to satisfy all our customers.

M2S060-FGG676 Payment Methods

M2S060-FGG676 Shipping Methods

If you have any question about M2S060-FGG676, please do not hesitate to contact us!
Website: https://www.heisener.com
E-mail: salesdept@heisener.com